

DPAM-23-11.0-S-8-1

DPAM-23-11.0-S-8-1 Information

Heisener.com	Manufacturer Category Description	DPAM-23-11.0-S-8-1 Samtec Inc. Connectors, Interconnects Rectangular Connectors - Arrays, Edge Type, Mezzanine (Board to Board) .085 PITCH ELEVATED DP TERMINAL	
	Package	- For the pricing/inventory/lead time, please contact us	
For Reference Only		Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



DPAM-23-11.0-S-8-1 Specifications

Manufacturer Part Number	DPAM-23-11.0-S-8-1		
Manufacturer	Samtec Inc.		
Category	Connectors, Interconnects		
	Rectangular Connectors - Arrays, Edge Type, Mezzanine (Board to Board)		
Package	-		
Series	DP Array? DPAM		
Connector Type	Differential Pair Array, Male		
Number of Positions	336 Signal (168 Pair)		
Pitch	0.085" (2.16mm)		
Number of Rows	8		
Mounting Type	Surface Mount		
Features	-		
Contact Finish	Gold		
Contact Finish Thickness	30µin (0.76µm)		
Mated Stacking Heights	14mm		
Height Above Board	0.421" (10.70mm)		
	Report errors'		

DPAM-23-11.0-S-8-1 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

DPAM-23-11.0-S-8-1 Payment Methods



DPAM-23-11.0-S-8-1 Shipping Methods



If you have any question about DPAM-23-11.0-S-8-1, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com